



$V_{in} = 24V_{in} \pm 10\%$

5Vout @ 0.3A (Isolated)

5Vout Primary (Unused)

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Number: PMP9362	Rev: E1	Designed for: Public Release	Mod. Date: 1/14/2015
SVN Rev: Not in version control	Assembly Variant: 001	Project Title: LM5017 Sync-Flyback	Sheet Title: *
Drawn By: *	File: PMP9362 Schematics.SchDoc	Sheet: 1 of 2	Size: B
Engineer: David Baba	Contact: http://www.ti.com/support		



H1 NY PMS 440 0025 PH H2 NY PMS 440 0025 PH H3 NY PMS 440 0025 PH H4 NY PMS 440 0025 PH

H5 1902C H6 1902C H7 1902C H8 1902C

~~DNP~~ FID1 ~~DNP~~ FID2 ~~DNP~~ FID3

PCB: PMP9291 Rev4
PMP9291 Rev4

PCB
LOGO
Texas Instruments

Label Table

Variant	Label Text
001	ChangeMe!
002	ChangeMe!

LBL1
PCB Label
Size: 0.65" x 0.20 "

ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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